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Form PTO-1595 (modified)

(Rev. 03/01) OMB No. 0651-0027	01921091 U.S. Patent and Trademark	Onice				
To the Honorable Commissioner of Patents	and Trademarks: Please record the attached original documents or copy thereof.					
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):					
Katsumi SHIMADA	NITTO DENKO CORPORATION 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka, Japan					
3	1-2, Simnonozumi 1-chome, Daraki-sin, Osaka, Japan					
(1)	ဗူးက					
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Additional name(s) of conveying party(ies) attached?	Yes ☑ No	22				
3. Nature of conveyance:	8					
☑ Assignment ☐ Merger		_				
☐ Security Agreement ☐ Change of Name						
☐ Other						
Execution Date: November 16, 2001	Additional name(s) & address(es) attached? ☐ Yes ☑ No					
4. Application number(s) or patent number(s):						
If this document is being filed together with a	new application, the execution date of the application is: November 16, 200	i				
A. Patent Application No.(s)	B. Patent No.(s)					
Addition	ial numbers attached? 🔲 Yes 🗹 No					
5. Name and address of party to whom correspo						
concerning document should be mailed:	1					
SUGHRUE MION, PLLC	7. Total fee (37 CFR 3.41): \$40.00 ☑ Enclosed. Please charge any underpayment in connection	n				
2100 Pennsylvania Avenue, N.W. Suite 800	with this Assignment to Deposit Account No. 19-4880.	**				
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9. Statement and signature.		of the				
To the best of my knowledge and belief, the fo	oregoing information is true and correct and any attached copy is a true copy					
original document	December 13, 2001					
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Total number of pag	es including cover sheet, attachments, and documents: 2					
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Assignment

Whereas I/We, Katsumi SHIMADA, of Osaka, Japan

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hereinafter called assignor(s), have invented certain improvements in PROCESS FOR PRODUCING EPOXY RESIN COMPOSITION FOR PHOTOSEMICONDUCTOR ELEMENT ENCAPSULATION

and executed an application for Letters Patent of the United States of America therefor on November 16, 2001; and

Whereas.

NITTO DENKO CORPORATION of

1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka, Japan (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor:

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and I/we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

		S SUGHAUE, MICH. ZIMM, MACPEAR & SEAS OF
100 Pennsylvania Avenue, N	I.W., Washington, D.C. 2	0037-3202 to insert here in parentheses (Application
number	filed) the filing date and application
number of said application	when known.	
Date: November 16, 2001	stKatsure	Shimedex-
Date:	s/	

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

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PATENT REEL: 012379 FRAME: 0159